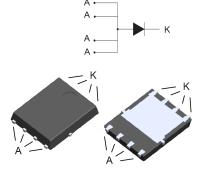


## 50 V, 20 A field effect rectifier



PowerFLAT<sup>TM</sup> 5x6 (non-contractual)

#### **Features**

- · ST patented rectifier process
- Stable leakage current over reverse voltage
- · Low forward voltage drop
- High frequency operation
- ECOPACK<sup>®</sup>2 compliant

### **Applications**

- · Set-top box
- Battery charger
- DC / DC converter

### **Description**

This single rectifier is based on a proprietary technology, enabling to achieve the best in class  $V_F/I_R$  for a given silicon surface.

Packaged in PowerFLAT™ 5x6, the FERD20U50 is optimized for use in rectification and freewheeling operations in switch mode power supplies.

| Product status |
|----------------|
| FERD20U50      |

| Product summary      |        |  |  |
|----------------------|--------|--|--|
| Symbol               | Value  |  |  |
| I <sub>F(AV)</sub>   | 20 A   |  |  |
| $V_{RRM}$            | 50 V   |  |  |
| T <sub>j(max.)</sub> | 150 °C |  |  |
| $V_{F(typ.)}$        | 0.44 V |  |  |

### 1 Characteristics

Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified, anode terminals short circuited)

| Symbol              | Parameter   | Value          | Unit |    |
|---------------------|---|----------------|------|----|
| V <sub>RRM</sub>    | Repetitive peak reverse voltage                       | 50             | V    |    |
| I <sub>F(RMS)</sub> | Forward rms current                                   | 45             | Α    |    |
| I <sub>F(AV)</sub>  | Average forward current, δ = 0.5 square wave          | 20             | Α    |    |
| I <sub>FSM</sub>    | Surge non repetitive forward current                  | 180            | Α    |    |
| T <sub>stg</sub>    | Storage temperature range                             | -65 to +175    | °C   |    |
| T <sub>j</sub>      | Maximum operating junction temperature <sup>(1)</sup> | PowerFlat™ 5x6 | +150 | °C |

<sup>1.</sup>  $(dP_{tot}/dT_j) < (1/R_{th(j-a)})$  condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance parameter

| Symbol        | Parameter        | Max. value | Unit |
|---------------|------------------|------------|------|
| $R_{th(j-c)}$ | Junction to case | 2.6        | °C/W |

For more information, please refer to the following application note:

• AN5046 : Printed circuit board assembly recommendations for STMicroelectronics PowerFLAT™ packages

Table 3. Static electrical characteristics (anode terminals short circuited)

| Symbol  | Parameter               | Test conditions         |                       | Min. | Тур. | Max. | Unit |
|---|-------------------------|-------------------------|-----------------------|------|------|------|------|
| I <sub>R</sub> <sup>(1)</sup> Reverse leakage current | Doverse leekage current | T <sub>j</sub> = 25 °C  | $V_R = V_{RRM}$       | -    |      | 800  | μA   |
|   | Reverse leakage current | T <sub>j</sub> = 125 °C |                       | -    | 30   | 60   | mA   |
| V <sub>F</sub> <sup>(2)</sup> Forwa                   | Forward voltage drop    | T <sub>j</sub> = 25 °C  | I <sub>F</sub> = 10 A | -    | 0.37 |      | V    |
|   |                         | T <sub>j</sub> = 125 °C |                       | -    | 0.33 |      |      |
|   |                         | T <sub>j</sub> = 25 °C  | I <sub>F</sub> = 20 A | -    | 0.45 | 0.51 | v    |
|   |                         | T <sub>j</sub> = 125 °C |                       | -    | 0.44 |      |      |

- 1. Pulse test:  $t_p$  = 5 ms,  $\delta$  < 2%
- 2. Pulse test:  $t_p$  = 380  $\mu$ s,  $\delta$  < 2%

To evaluate the conduction losses, use the following equation:

 $P = 0.25 \times I_{F(AV)} + 0.011 \times I_{F}^{2}_{(RMS)}$ 

For more information, please refer to the following application notes related to the power losses :

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode

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### 1.1 Characteristics (curves)

Figure 1. Average forward power dissipation versus average forward current (anode terminals short circuited)

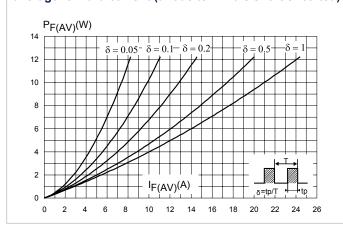


Figure 2. Average forward current versus ambient temperature ( $\delta$  = 0.5, anode terminals short circuited)

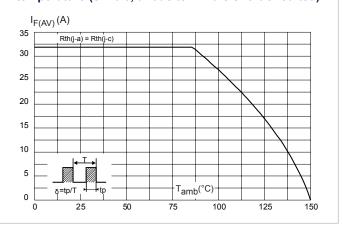


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

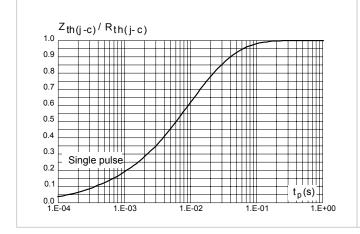


Figure 4. Reverse leakage current versus reverse voltage applied (typical values)

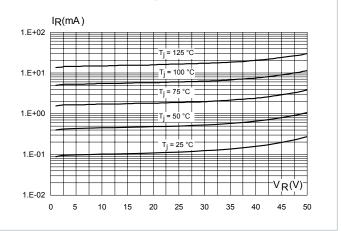


Figure 5. Junction capacitance versus reverse voltage applied (typical values)

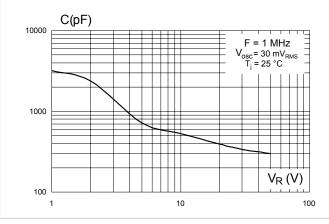
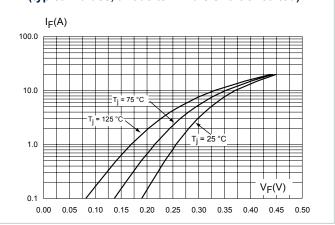


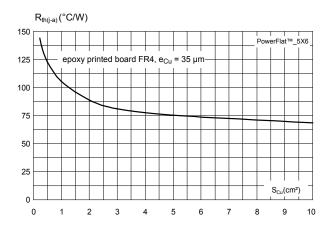
Figure 6. Forward voltage drop versus forward current (typical values, anode terminals short circuited)



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Figure 7. Thermal resistance junction to ambient versus copper surface under tab (typical values)



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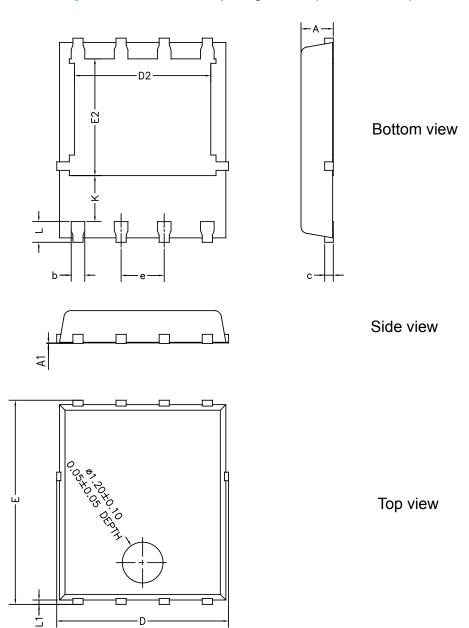
# 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

## 2.1 PowerFLAT™ 5x6 package information

- Epoxy meets UL 94,V0
- Cooling method: by conduction (C)

Figure 8. PowerFLAT™ 5x6 package outline (non-contractual)



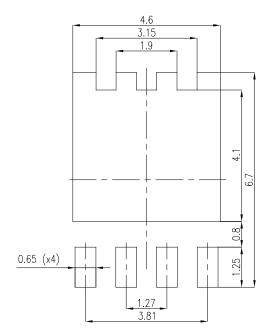
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Table 4. PowerFLAT™ 5x6 mechanical data

| Dimensions |             |      |       |                             |       |       |
|------------|-------------|------|-------|-----------------------------|-------|-------|
| Ref        | Millimeters |      |       | Inches (for reference only) |       |       |
| Kei        | Min.        | Тур. | Max.  | Min.                        | Тур.  | Max.  |
| А          | 0.80        |      | 1.00  | 0.031                       |       | 0.039 |
| A1         | 0.00        |      | 0.05  | 0.000                       |       | 0.002 |
| b          | 0.30        |      | 0.50  | 0.01                        |       | 0.02  |
| С          |             | 0.25 |       |                             | 0.010 |       |
| D          | 4.80        |      | 5.40  | 0.189                       |       | 0.212 |
| D2         | 3.91        |      | 4.45  | 0.154                       |       | 0.175 |
| е          |             | 1.27 |       |                             | 0.050 |       |
| E          | 5.90        |      | 6.35  | 0.232                       |       | 0.250 |
| E2         | 3.34        |      | 3.70  | 0.138                       |       | 0.146 |
| L          | 0.50        |      | 0.80  | 0.020                       |       | 0.031 |
| K          | 1.10        |      | 1.575 | 0.015                       |       | 0.023 |
| L1         | 0.05        | 0.15 | 0.25  | 0.002                       | 0.006 | 0.009 |

Figure 9. PowerFLAT™ 5x6 recommended footprint (dimensions are in mm)



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# **3** Ordering information

**Table 5. Ordering information** 

| Order code      | Marking  | Package        | Weight Base qty. |      | Delivery mode |
|-----------------|----------|----------------|------------------|------|---------------|
| FERD20U50DJF-TR | FD20 U50 | PowerFLAT™ 5x6 | 95 mg            | 3000 | Tape and reel |

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# **Revision history**

**Table 6. Document revision history** 

| Date        | Version | Changes   |
|-------------|---------|---|
| 25-Mar-2014 | 1       | Initial release.  |
| 06-Jun-2014 | 2       | Updated RPN   |
| 06-Aug-2015 | 3       | Updated Table 2 and reformatted to current standard.  |
| 09-Nov-2018 | 4       | Updated Section Cover image and Section 2.1 PowerFLAT™ 5x6 package information. Added Section Applications.     |
| 05-Feb-2019 | 5       | Updated Figure 8. PowerFLAT™ 5x6 package outline (non-contractual) and Table 4. PowerFLAT™ 5x6 mechanical data. |

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